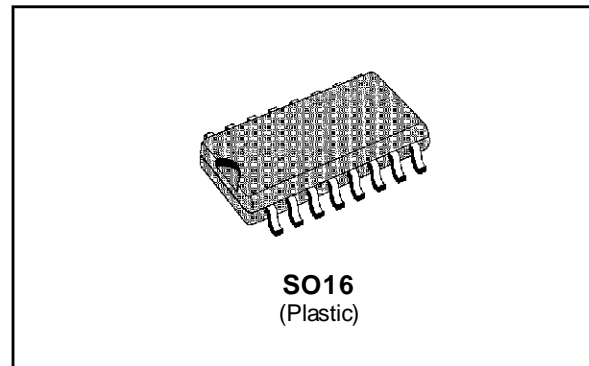


TELEPHONE SET INTERFACE

FEATURES

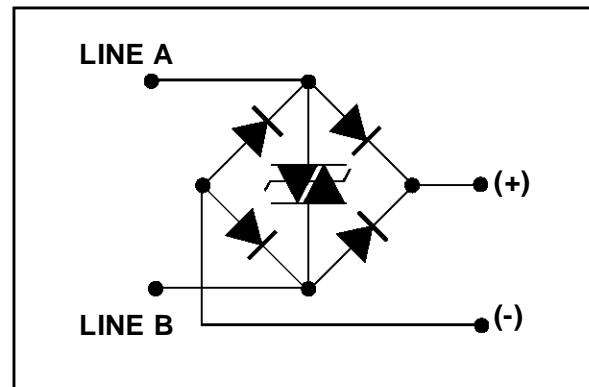
- SINGLE DEVICE PROVIDING :
DIODE BRIDGE
BIDIRECTIONAL PROTECTION
- CROWBAR PROTECTION
- PEAK PULSE CURRENT :
 $I_{PP} = 30A, 10/1000 \mu s$
- VOLTAGE RANGE FROM 120V to 270V
- Maximum current : $I_o = 0.5$



IN ACCORDANCE WITH FOLLOWING STANDARDS :

CCITT K17 - K20	{	10/700 μs	1.5 kV
		5/310 μs	38 A
VDE 0433	{	10/700 μs	2 kV
		5/200 μs	50 A
CNET	{	0.5/700 μs	1.5 kV
		0.2/310 μs	38 A

FUNCTIONAL DIAGRAM



ABSOLUTE RATINGS (limiting values) ($-40^{\circ}C \leq T_{amb} \leq +85^{\circ}C$)

Symbol	Parameter		Value	Unit
I_{PP}	Peak pulse current	10/1000 μs 5/310 μs 2/10 μs	30 40 75	A
I_o	Maximum current		0.5	A
I_{TSM}	Non repetitive surge peak on-state current	$t_p = 10 ms$ $t_p = 1 s$	5 3.5	A
dv/dt	Critical rate of rise of off-state voltage	67% V_{BR}	5	KV/ μs
T_{stg} T_j	Storage and operating junction temperature range		- 40 to + 150 150	$^{\circ}C$ $^{\circ}C$

TSIxxxB5

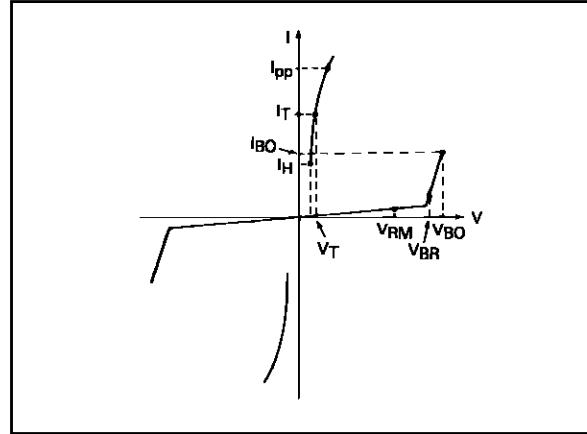
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction-ambient thermal resistance - mounting on FR4	80	°C/W

ELECTRICAL CHARACTERISTICS

$T_{amb} = 25^{\circ}\text{C}$

Symbol	Parameter
V_{RM}	Stand-off voltage
V_{BR}	Breakdown voltage
V_{BO}	Breakover voltage
I_H	Holding current
V_T	On-state voltage
V_F	Forward Voltage Drop
I_{BO}	Breakover current
I_{PP}	Peak pulse current



PARAMETERS RELATED TO THE PROTECTION DEVICE

Types	I_R @ V_{RM}		V_{BO} @ I_{BO}	I_H	I_{BO}		V_T
	max		max note1	min note1	min note1	max	max note2
	μA	V	V	mA	mA	mA	V
TSI120B5	1 5	50 120	180	150	50	400	8
TSI150B5	1 5	50 150	230	150	50	400	8
TSI180B5	1 5	50 180	250	150	50	400	8
TSI200B5	1 5	50 200	290	150	50	400	8
TSI270B5	1 5	50 270	380	150	50	400	8

PARAMETERS RELATED TO THE DIODE BRIDGE

Symbol	Test conditions	Value	Unit
V_F	$I_F = 20\text{mA}$ note 3 $I_F = 100\text{mA}$ note 3	0.9 1.0	V
C	note 4	200	pF

All parameters are tested at 25°C , except where indicated

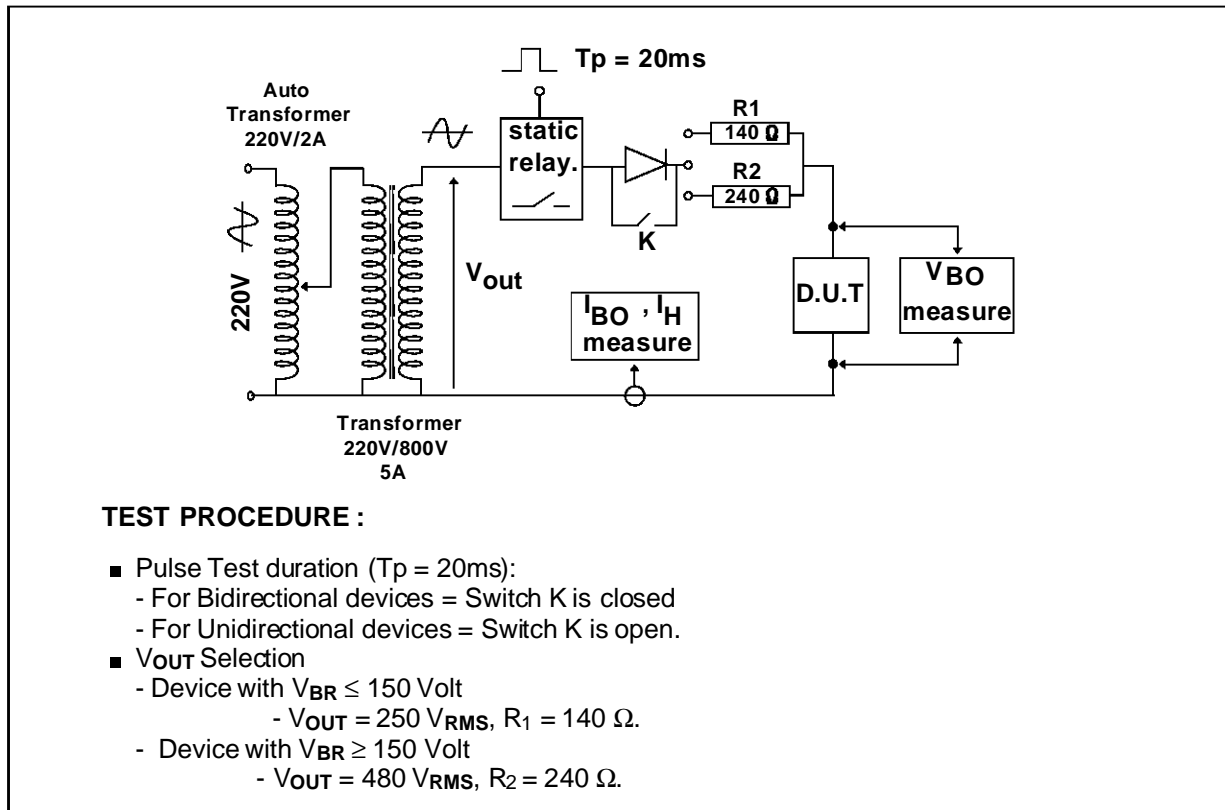
Note 1 : See test conditions for V_{BO} , I_{BO} , I_H parameters

Note 2 : Square pulse $t_p = 500\ \mu\text{s}$ - $I_T = 5\text{A}$.

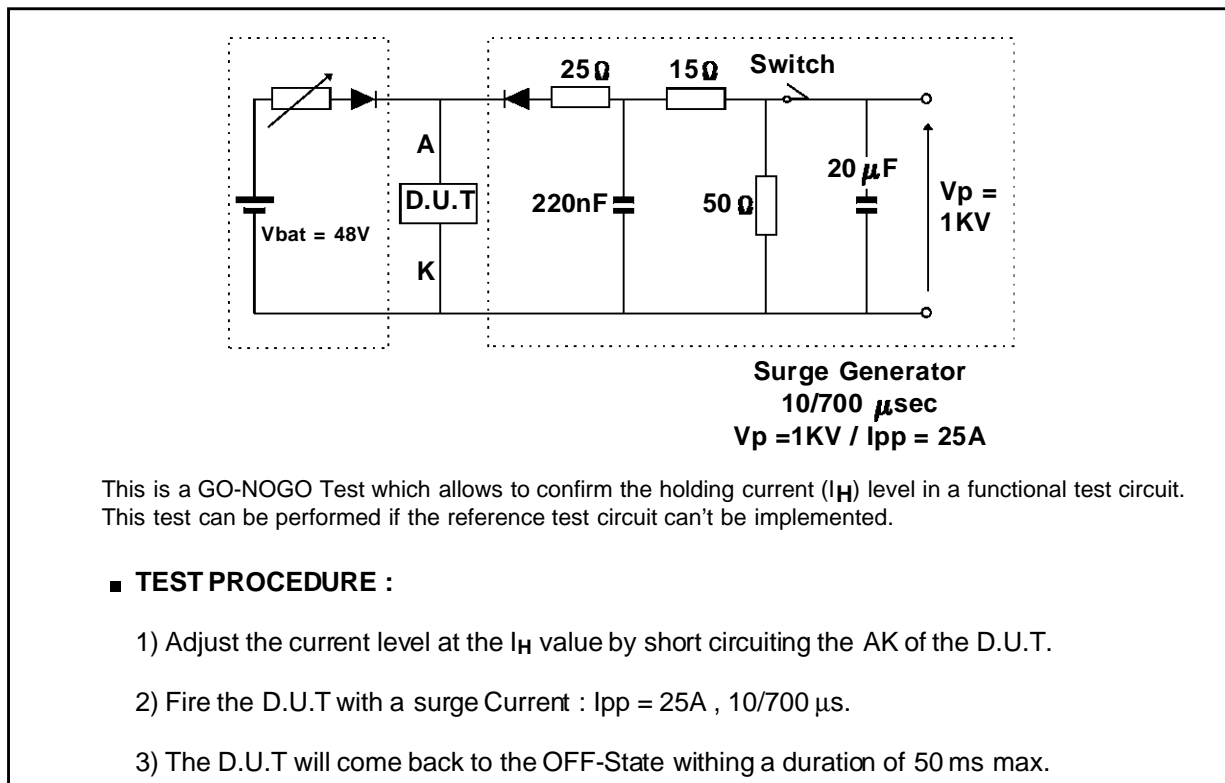
Note 3 : V_F is given for one diode

Note 4 : $V_R = 0\text{V}$, $F = 1\text{MHz}$.

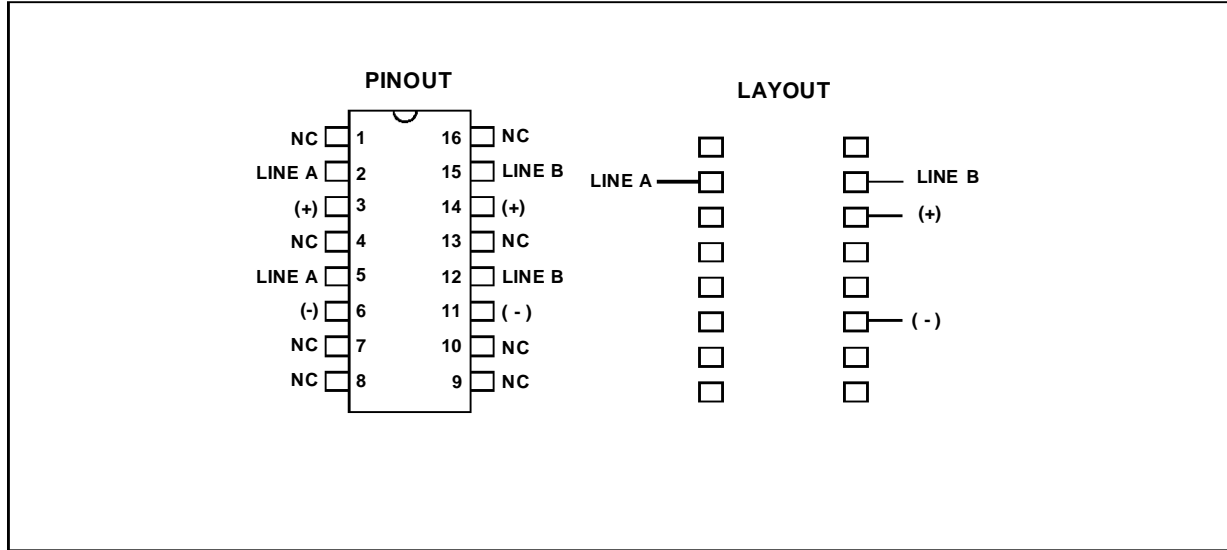
REFERENCE TEST CIRCUIT FOR I_H , I_{BO} and V_{BO} parameters :



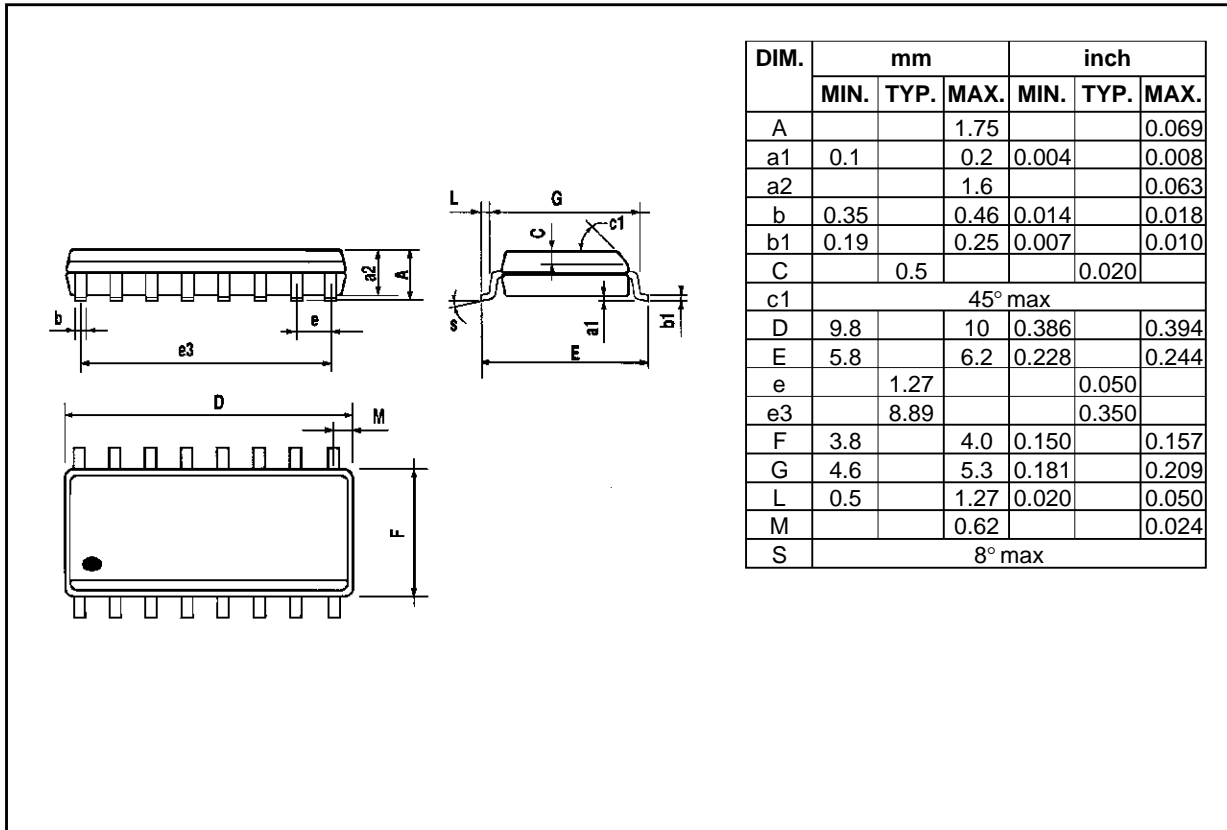
FUNCTIONAL HOLDING CURRENT (I_H) TEST CIRCUIT = GO - NOGO TEST.



PINOUT CONFIGURATION AND LAYOUT RECOMMENDATIONS :



PACKAGE MECHANICAL DATA



MARKING : LOGO, DATE CODE, DEVICE CODE.

DEVICE	TSI120B5	TSI150B5	TSI180B5	TSI200B5	TSI270B5
MARKING	TSI120	TSI150	TSI180	TSI200	TSI270

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